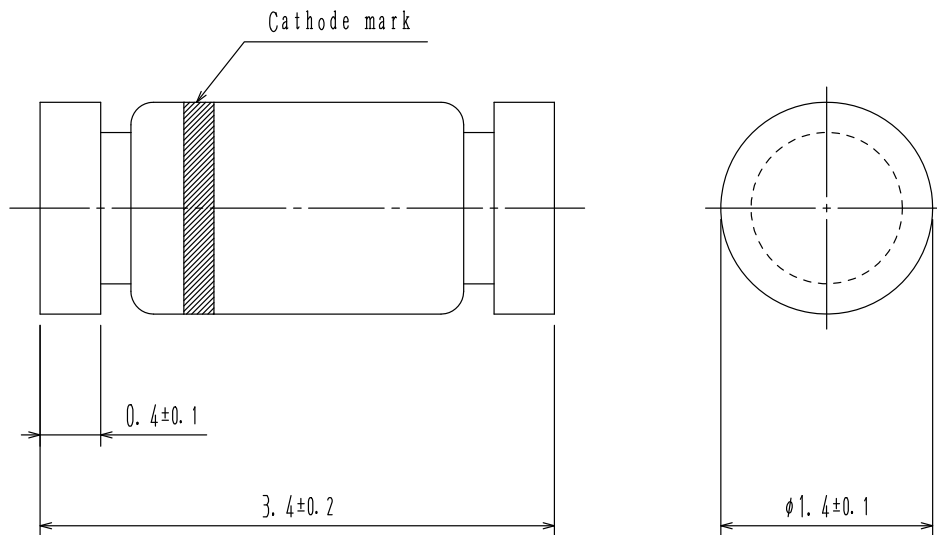


MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS




MiniMELF / SOD-80
CASE 100AD
ISSUE O

DATE 30 APR 2012



NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE:
JEDEC DO-213, VARIATION AC.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C)  CORNER RADIUS IS OPTIONAL.
- D) DRAWING FILE NAME: SOD80A REV01

DOCUMENT NUMBER:	98AON79582E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	MINIMELF / SOD-80	PAGE 1 OF 1

onsemi and **ONSEMI** are trademarks of Semiconductor Components Industries, LLC dba **onsemi** or its subsidiaries in the United States and/or other countries. **onsemi** reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. **onsemi** does not convey any license under its patent rights nor the rights of others.